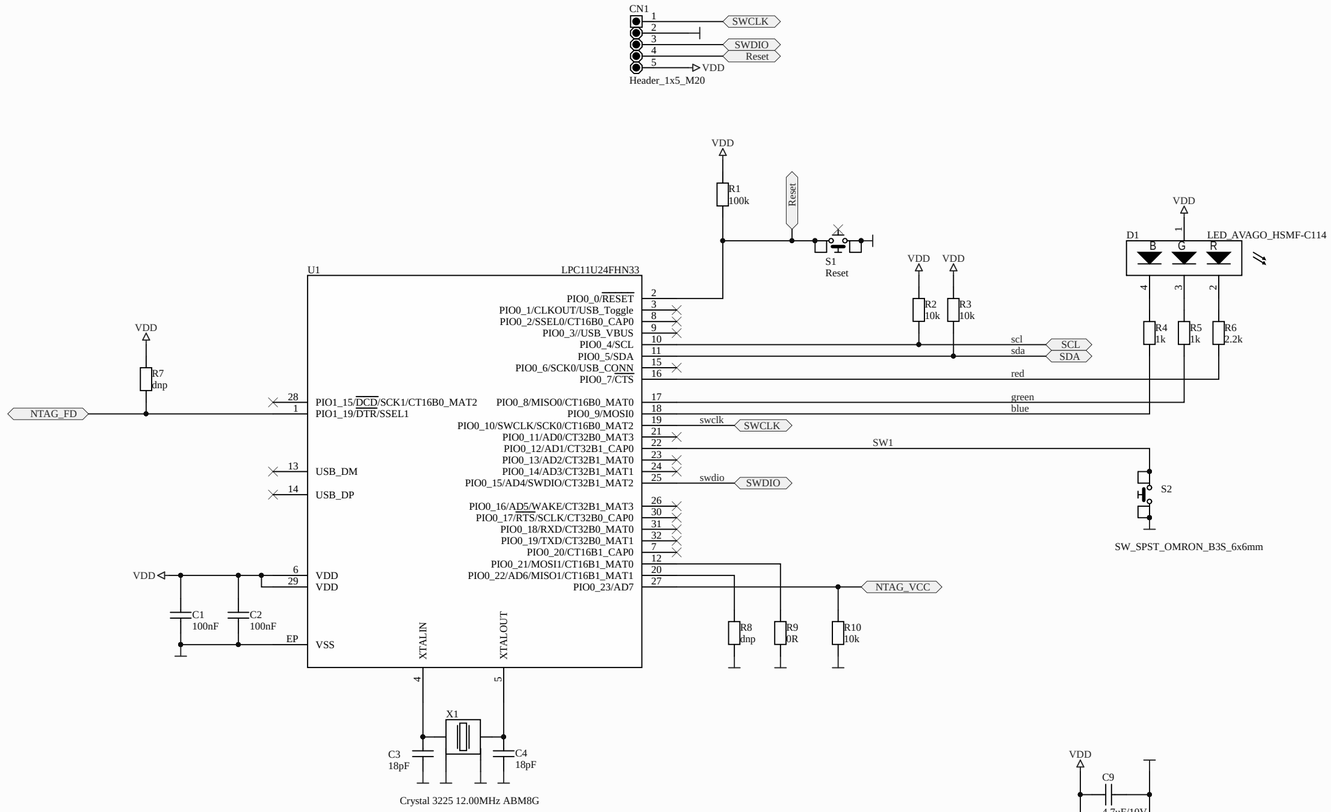
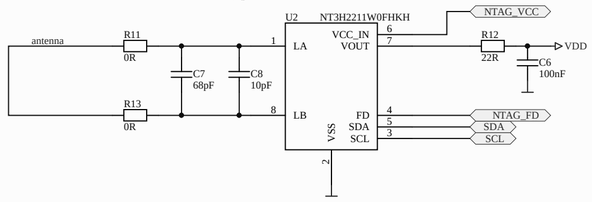


matched 10.2.2017, tpi



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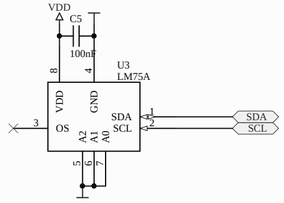

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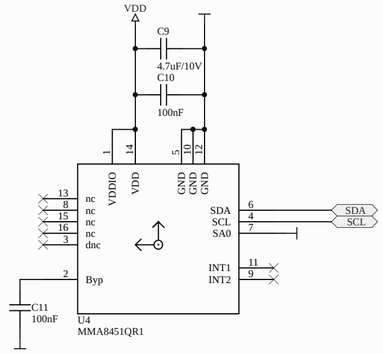

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Date: 10.02.2017	Time: 09:30:52	Sheet * of *	
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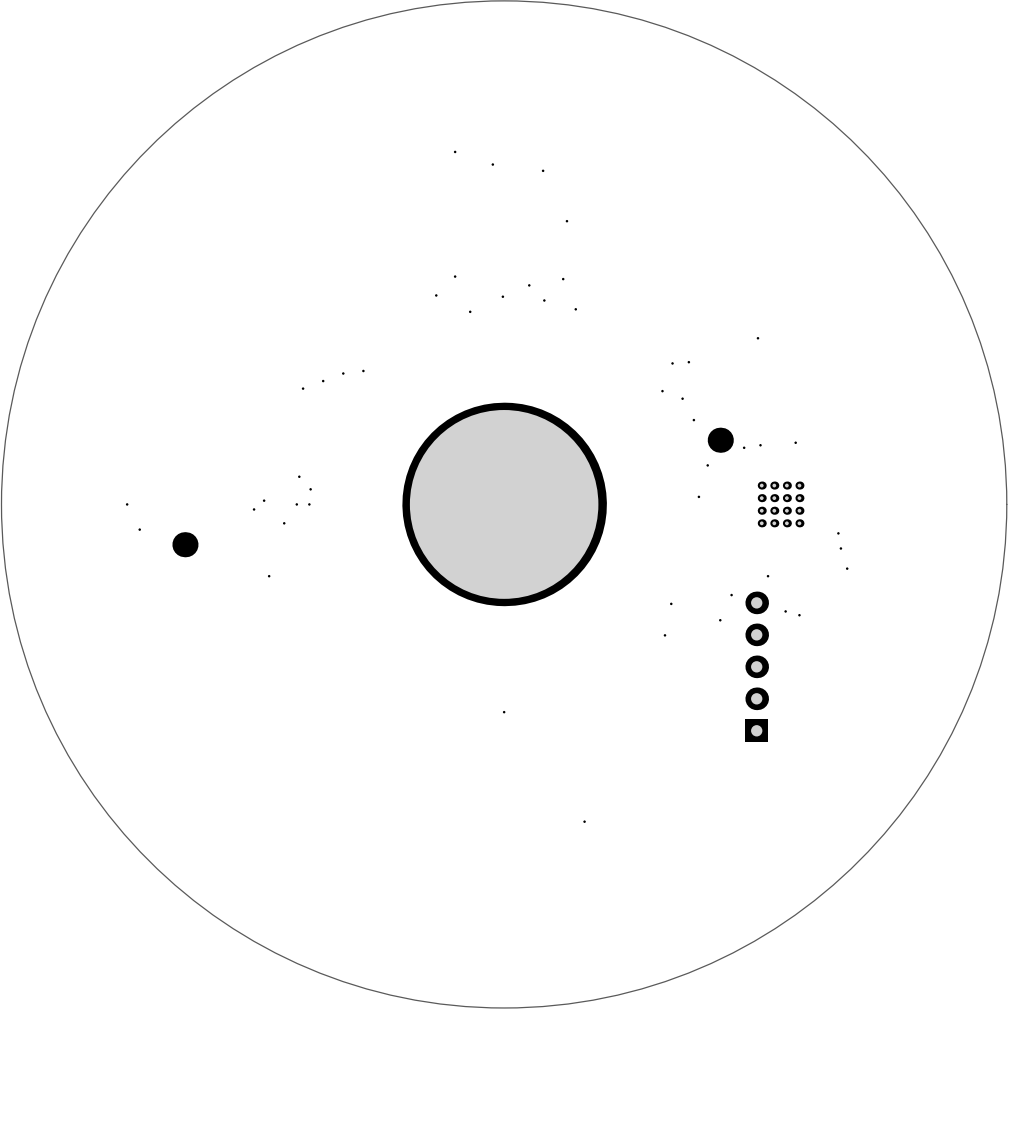

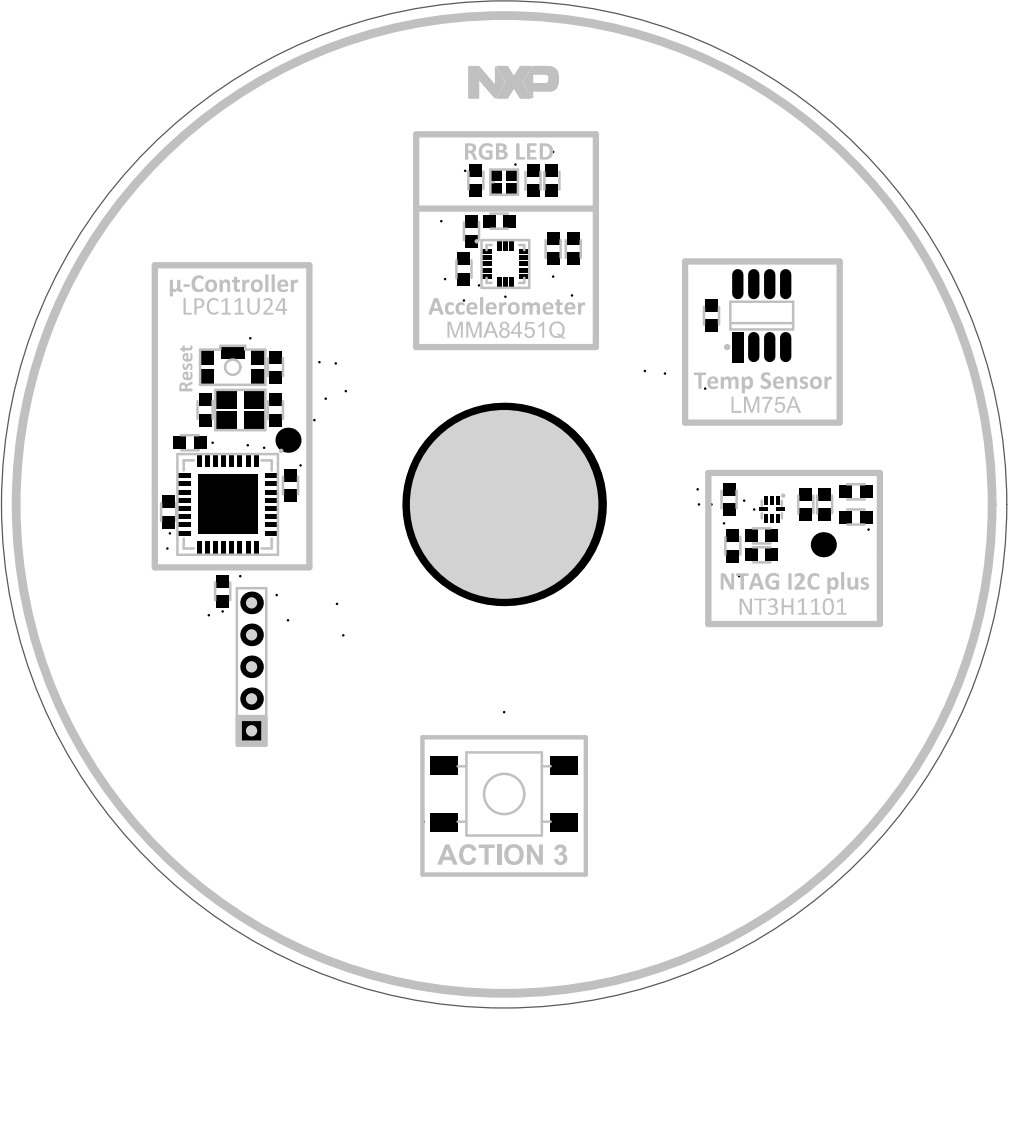
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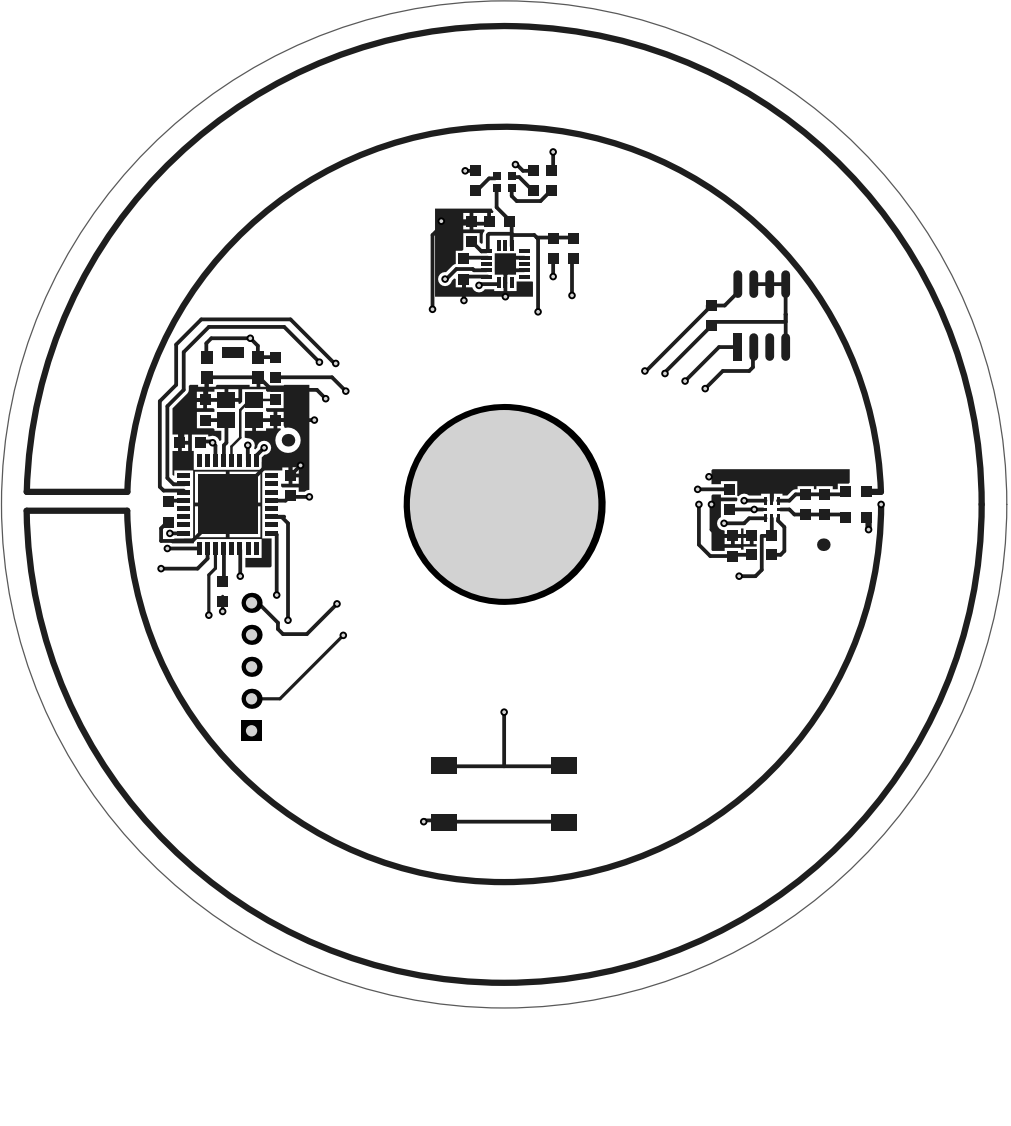
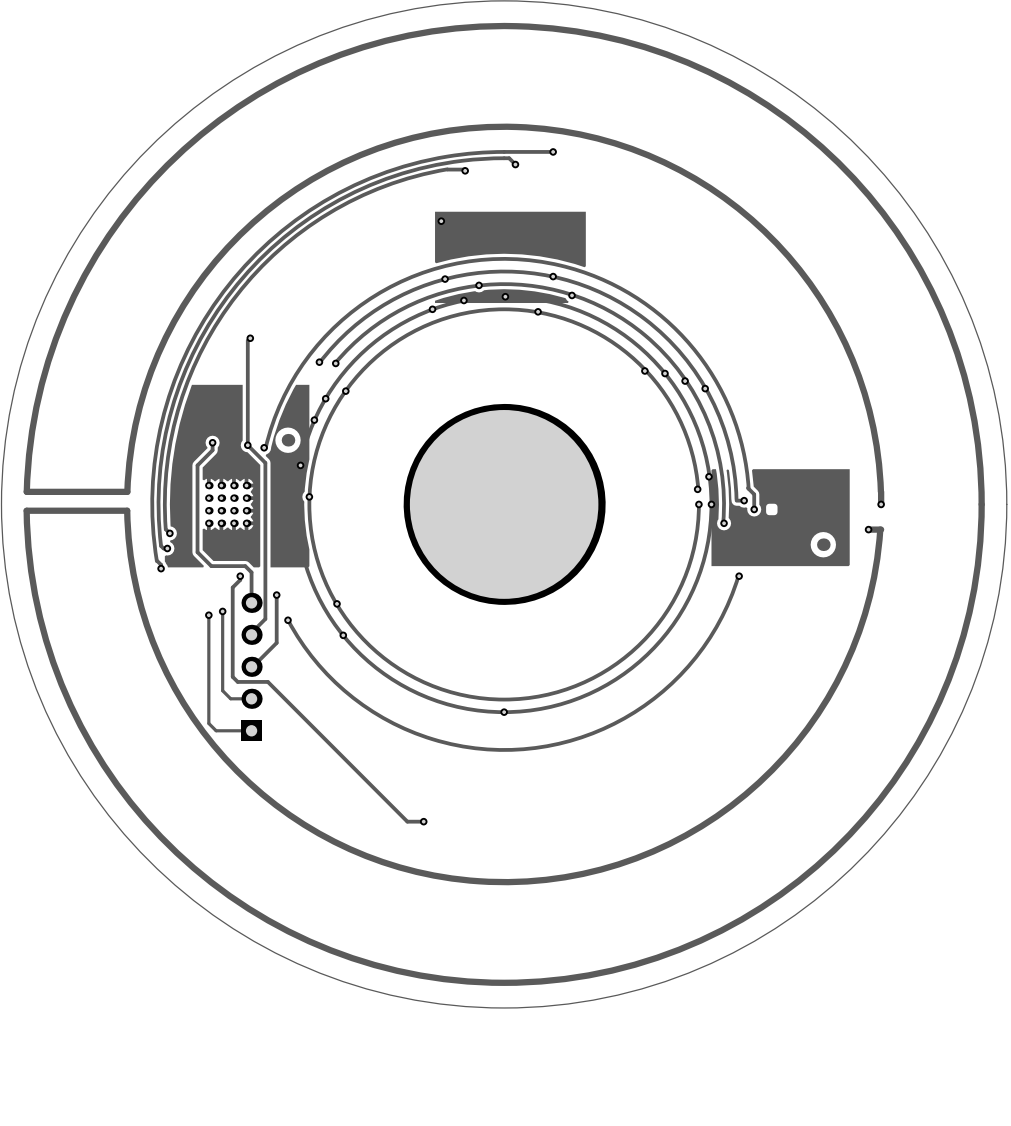
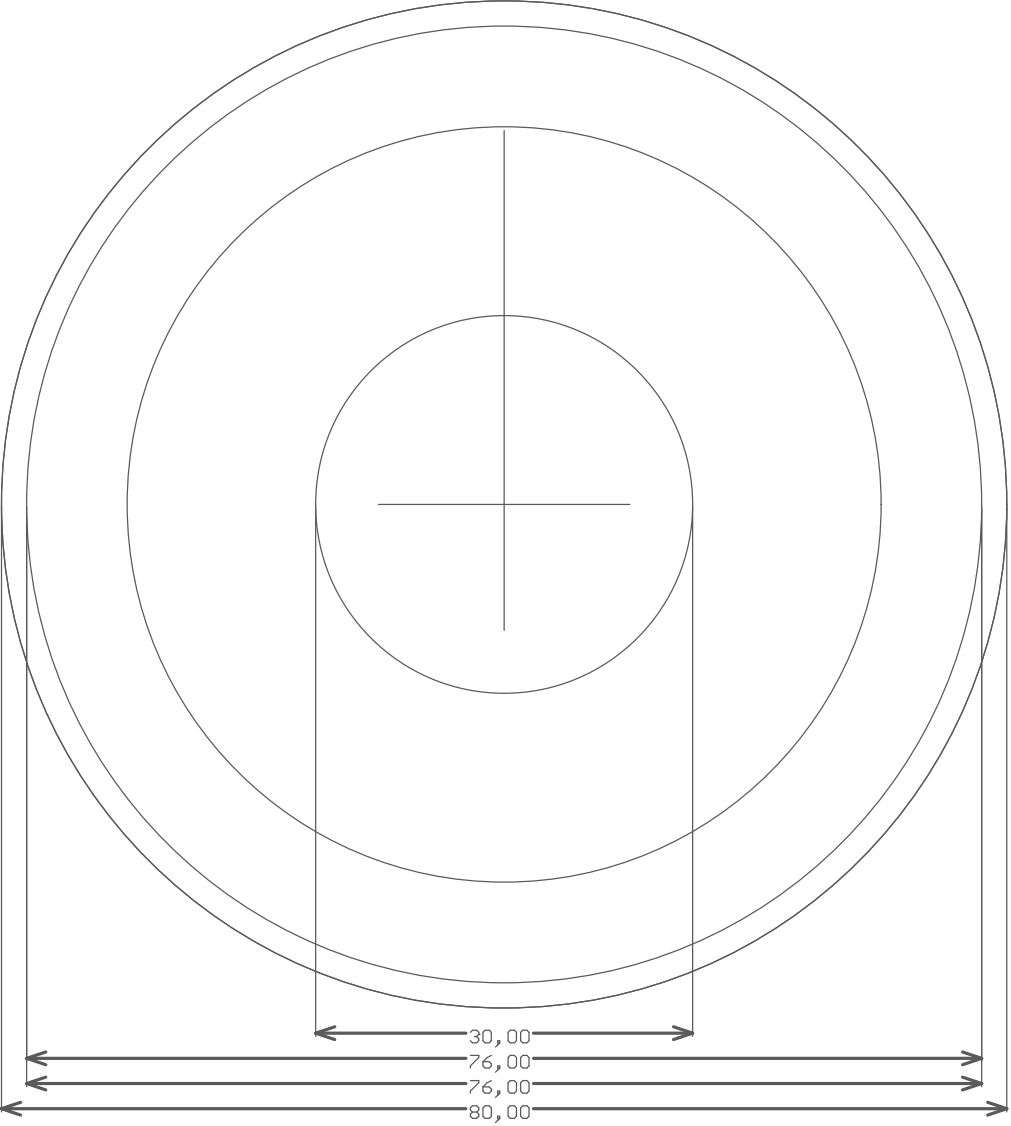
MMA8451Q
µ-Controller
LPC11U24
Reset
Temp Sensor
LM75A
NTAG I2C plus
NT3H1101
ACTION 3






30,00
76,00
76,00
80,00

Design Rules Verification Report

Filename : D:_mpa_Designs\NXP_Ntag_Demo\NTAG_1v0\NTAG_1v0.PcbDoc

Warnings 0
Rule Violations 1

Warnings	
Total	0

Rule Violations	
Clearance Constraint (Gap=0.15mm) (All),(All)	0
Clearance Constraint (Gap=0.25mm) (IsRegion),(All)	0
Clearance Constraint (Gap=0.5mm) (HasFootprint('FIDUCIAL')),(All)	0
Short-Circuit Constraint (Allowed=No) (All),(All)	0
Un-Routed Net Constraint ((All))	0
Width Constraint (Min=0.15mm) (Max=2mm) (Preferred=0.3mm) (All)	0
Routing Via (MinHoleWidth=0.3mm) (MaxHoleWidth=0.8mm) (PreferredHoleWidth=0.3mm) (MinWidth=0.6mm)	0
Differential Pairs Uncoupled Length using the Gap Constraints (Min=0.254mm) (Max=0.254mm) (Prefered=0.254mm)	0
Power Plane Connect Rule(Relief Connect)(Expansion=0.5mm) (Conductor Width=0.2mm) (Air Gap=0.2mm)	0
Hole Size Constraint (Min=0.3mm) (Max=6mm) (All)	1
Pads and Vias to follow the Drill pairs settings	0
Hole To Hole Clearance (Gap=0.2mm) (All),(All)	0
Minimum Solder Mask Sliver (Gap=0.15mm) (All),(All)	0
Net Antennae (Tolerance=0mm) (All)	0
Component Clearance Constraint (Horizontal Gap = 0.1mm, Vertical Gap = 0.2mm) (All),(All)	0
Height Constraint (Min=0mm) (Max=25.4mm) (Prefered=12.7mm) (All)	0
Total	1

Hole Size Constraint (Min=0.3mm) (Max=6mm) (All)
Hole Size Constraint: (15mm > 6mm) Pad Free-1(50mm,50mm) on Multi-Layer Actual Hole Size = 15mm